

## Product Information Sheet EPO-TEK<sup>®</sup> OG198-55-1

Date: September 2017	Rev: III		
Material Description:	EPO-TEK® OG198-55-1 is a single component, high thixotr	opy cloudy UV cure epoxy which is electrical	ly
	and thermally insulating. It is a thixotropic version of EPO-T	EK® OG198-54.	
Number of Components:	Single	Recommended Cure	
Mix Ratio by Weight:	N/A	Iron-Doped Mercury Flood Lamp > 30 set	ec.
Specific Gravity:	1.15	100 mW/cm <sup>2</sup> @ 240-365 nm	
Pot Life:	N/A	Alternative Cures*	
Shelf Life:	One year refrigerated	Iron-Doped Mercury Spot Lamp > 30 set	ec.
		365nm LED Flood Lamp > 30 s	ec.
		Pulsed Mercury Lamp > 30 s	ec.
		UV Cure is complete after 24 hours	
<u>NOTES:</u>		from UV Exposure	
		* Contact Technical Services for application-	

• Container(s) should be kept closed when not in use.

• Filled systems should be stirred thoroughly before mixing and prior to use.

Performance properties (rheology, conductivity, others) of the product may vary from those stated on the data sheet when bi-pak/syringe packaging or post-processing of any kind is performed. Epoxy's warranties shall not apply to any products that have been reprocessed or repackaged from Epoxy's delivered status/container into any other containers of any kind, including but not limited to syringes, bi-paks, cartridges, pouches, tubes, capsules, films or other
Thermal post-cure beneficial - contact techserv@epotek.com for recommendations.

specific variations

MATERIAL CHARACTERISTICS: Cure condition: Varies as required \*Testing on lot acceptance basis Data below is not guaranteed. To be used as a guide only, not as a specification. Different batches, conditions and applications yield differing results.

PHYSICAL PROPERTIES:			
* Color (before cure):	Cloudy		
* Consistency:	Smooth thixotropic paste		
* Viscosity (23°C) @ 100 rpm:	1,200 - 2,000 cPs		
Thixotropic Index:	5.6		
* Glass Transition Temp:	≥ 120 °C (Dynamic Cure:20-200°C/ISO 25 Min; Ramp -10-200°C @ 20°C/Min)		
Coefficient of Thermal Expansion (CTE):			
Belo	<b>w Tg:</b> 72 x 10 <sup>-6</sup> in/in°C		
Abov	<b>/e Tg:</b> 120 x 10 <sup>-6</sup> in/in°C		
Shore D Hardness:	85		
Die Shear @ 23°C:			
UV Cure:	≥ 20 Kg   7,112     psi		
UV Cure + 23°C/24 Hours:	27.7 Kg 9,850.1 psi		
UV Cure + 80°C/1 Hour:	27.2 Kg 9,672.3 psi		
Degradation Temp:	354 °C		
Weight Loss: @ 20	0°C 0.23 %		
@ 25	0°C 0.73 %		
@ 30	0°C 2.13 %		
Suggested Operating Temperatur	re: < 300 °C (Intermittent)		
Storage Modulus:	489,872 psi		
* Particle Size:	≤ 20 microns		
OPTICAL PROPERTIES @ 23°C:			
Spectral Transmission:	≥ 97% @ 560-1,680 nm		
Refractive Index (uncured):	1.5023 @ 589 nm		

This information is based on data and tests believed to be accurate. Epoxy Technology, Inc. makes no warranties (expressed or implied) as to its accuracy and assumes no liability in connection with any use of this product.

EPOXY TECHNOLOGY, INC. 14 FORTUNE DRIVE, BILLERICA, MA 01821 (978) 667-3805, FAX (978) 663-9782 www.epotek.com